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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**IN RE THE APPLICATION OF**

Curwood, Inc.

SERIAL NO.: 09/431,931

FILED: November 1, 1999

FOR: Puncture Resistant, High Shrink Films,  
Blends and Process

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Group Art Unit No. 1773  
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I hereby certify that this correspondence is being deposited with  
the United States Postal Service as first class mail in an  
envelope addressed to "Commissioner for Patents, Washington,  
D.C. 20231" on March 30, 2001.

Name of person signing Deborah E. Dudek

Signature Deborah E. Dudek

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**TC 1700**

**TRANSMITTAL OF SECOND SUPPLEMENTAL INFORMATION DISCLOSURE  
STATEMENT UNDER 37 C.F.R. §1.97(C)**

The Commissioner of Patents  
and Trademarks  
Washington, D.C. 20231

Dear Sir:

The Second Supplemental Information Disclosure Statement transmitted herewith is  
believed to be filed before the mailing date of either a final action under §1.113 or a Notice of  
Allowance under §1.311.

The seven U.S. patents and three published New Zealand specifications were cited by  
Pechiney Emballage Flexible Europe in an opposition against corresponding New Zealand Patent  
Application 501099. These materials were received by our New Zealand associate on March 20,  
2001.



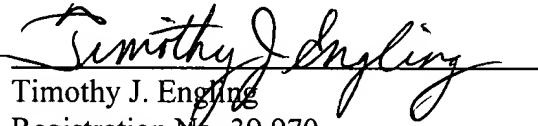
Should a final action or a Notice of Allowance be mailed on or before the filing date of this statement, applicant requests that the Second Supplemental Information Disclosure Statement be treated as a request for reconsideration under 37 C.F.R. §1.97(d).

A patent application processing fee under 37 C.F.R. §1.17(p) is enclosed in the amount of \$240. Please charge or rebate any discrepancy in the patent application processing fee to deposit account 12-0913.

Respectfully submitted,

March 30, 2001

Date

  
\_\_\_\_\_  
Timothy J. Engling  
Registration No. 39,970

Lee, Mann, Smith, McWilliams,  
Sweeney & Ohlson  
P.O. Box 2786  
Chicago, Illinois 60690-2786  
312-368-6661 Direct Line  
312-368-0034 Facsimile



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**SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT  
UNDER 37 C.F.R. §1.197(c)**

The Commissioner of Patents  
and Trademarks  
Washington, D.C. 20231

Dear Sir:

The examiner may wish to consider the documents attached on the Information Disclosure Statement with respect to the above identified application.

The references were cited in a New Zealand opposition against Curwood's New Zealand Patent Application 501099. We have enclosed the Statement of Case submitted by Pechiney Emballage Flexible Europe. The statement of the case indicates the proposed relevance of the documents by Pechiney Emballage Flexible Europe. The Statement of Case is submitted to represent full disclosure by Curwood, Inc., and it is not intended that the Patent and Trademark Office rely on any representations as accurate or correct.

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The identification of any documents herein is not intended to be and should not be understood as being in admission that such document, in fact, constitutes "prior art" within the meaning of applicable law. The "prior art" status of any patent or publication is a matter to be resolved during prosecution.

Applicant respectfully requests that the art cited herein be made of record in the above identified case.

Respectfully submitted,

March 30, 2001  
Date

  
\_\_\_\_\_  
Timothy J. Engling  
Registration No. 39,970

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